TEXAS INSTRUMENTS
Data sheet acquired from Harris Semiconductor
SCHS033C – Revised October 2003

CD4028B Types

BCD-to-Decimal Decoder

High-Voltage Types (20-Volt Rating)

■ CD4028B types are BCD-to-decimal or binary-to-octal decoders consisting of buffering on all 4 inputs, decoding-logic gates, and 10 output buffers. A BCD code applied to the four inputs, A to D, results in a high level at the selected one of 10 decimal decoded outputs. Similarly, a 3-bit binary code applied to inputs A through C is decoded in octal code at output 0 to 7 if D = "0". High drive capability is provided at all outputs to enhance dc and dynamic performance in high fan-out applications.

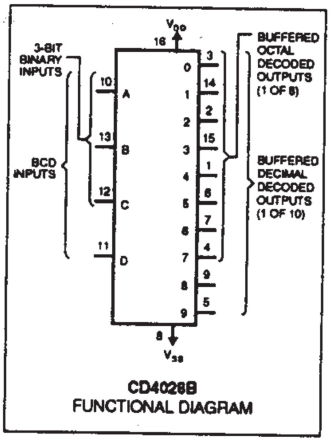
The CD4028B-Series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

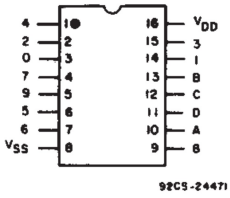
- BCD-to-decimal decoding or binary-to-octal decoding
- High decoded output drive capability
- "Positive logic" inputs and outputs. . . .
  . . . . . decoded outputs go high on selection
- Medium-speed operation. . . .
  t_{PHL}, t_{PLH} = 80 ns (typ.) @ V_{DD} = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range):
  1 V at V_{DD} = 5 V
  2 V at V_{DD} = 10 V
  2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC **Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"**

Applications:

- Code conversion
- Indicator-tube decoder
- Address decoding—memory selection control



CD4028B
FUNCTIONAL DIAGRAM



Top View
TERMINAL DIAGRAM

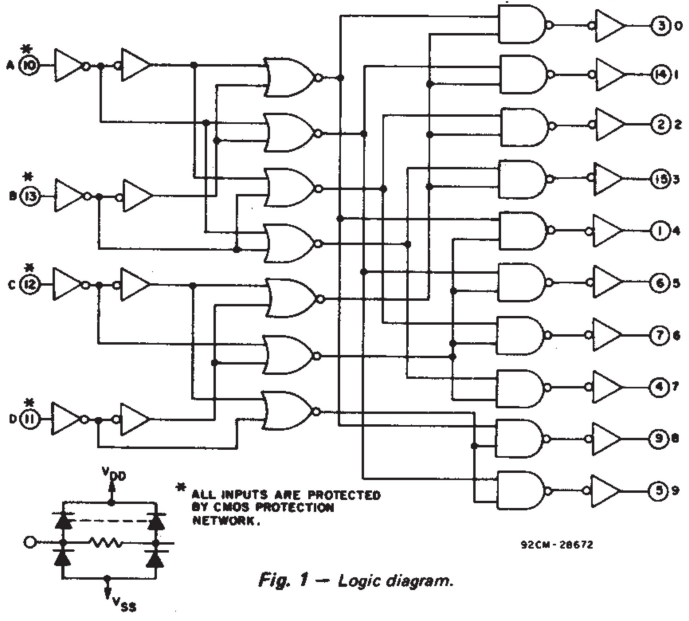


Fig. 1 — Logic diagram.

TABLE I – TRUTH TABLE

D	C	B	A	0	1	2	3	4	5	6	7	8	9
0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	0	0	1	0	1	0	0	0	0	0	0	0	0
0	0	1	0	0	0	1	0	0	0	0	0	0	0
0	0	1	1	0	0	0	1	0	0	0	0	0	0
0	1	0	0	0	0	0	0	1	0	0	0	0	0
0	1	0	1	0	0	0	0	0	1	0	0	0	0
0	1	1	0	0	0	0	0	0	0	1	0	0	0
0	1	1	1	0	0	0	0	0	0	0	1	0	0
1	0	0	0	0	0	0	0	0	0	0	0	1	0
1	0	0	1	0	0	0	0	0	0	0	0	0	1
1	0	1	0	0	0	0	0	0	0	0	0	0	0
1	0	1	1	0	0	0	0	0	0	0	0	0	0
1	1	0	0	0	0	0	0	0	0	0	0	0	0
1	1	0	1	0	0	0	0	0	0	0	0	0	0
1	1	1	0	0	0	0	0	0	0	0	0	0	0
1	1	1	1	0	0	0	0	0	0	0	0	0	0

1 = HIGH LEVEL 0 = LOW LEVEL

MAXIMUM RATINGS, *Absolute-Maximum Values:*

DC SUPPLY-VOLTAGE RANGE, (V_{DD})
(Voltages referenced to V_{SS} Terminal) ..... -0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to V_{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT ..... ±10mA
POWER DISSIPATION PER PACKAGE (P_D):
For T_A = -55°C to +100°C 500mW
For T_A = +100°C to +125°C ..... Derate Linearity at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) 100mW
OPERATING-TEMPERATURE RANGE (T_A) ..... -55°C to +125°C
STORAGE TEMPERATURE RANGE (T_{stg}) ..... -65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max ..... +265°C

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply Voltage Range (For T_A = Full Package Temperature Range)	3	18	V

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
								+25			
	V_O (V)	V_{IN} (V)	V_{DD} (V)	−55	−40	+85	+125	Min.	Typ.	Max.	
Quiescent Device Current, I_{DD} Max.	–	0,5	5	5	5	150	150	–	0.04	5	μA
	–	0,10	10	10	10	300	300	–	0.04	10	
	–	0,15	15	20	20	600	600	–	0.04	20	
	–	0,20	20	100	100	3000	3000	–	0.08	100	
Output Low (Sink) Current I_{OL} Min.	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	–	mA
	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	–	
	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	–	
Output High (Source) Current, I_{OH} Min.	4.6	0,5	5	−0.64	−0.61	−0.42	−0.36	−0.51	1	–	
	2.5	0,5	5	−2	−1.8	−1.3	−1.15	−1.6	−3.2	–	
	9.5	0,10	10	−1.6	−1.5	−1.1	−0.9	−1.3	−2.6	–	
	13.5	0,15	15	−4.2	−4	−2.8	−2.4	−3.4	−6.8	–	
Output Voltage: Low-Level, V_{OL} Max.	–	0,5	5	0.05				–	0	0.05	V
	–	0,10	10	0.05				–	0	0.05	
	–	0,15	15	0.05				–	0	0.05	
Output Voltage: High-Level, V_{OH} Min.	–	0,5	5	4.95				4.95	5	–	
	–	0,10	10	9.95				9.95	10	–	
	–	0,15	15	14.95				14.95	15	–	
Input Low Voltage, V_{IL} Max.	0.5, 4.5	–	5	1.5				–	–	1.5	V
	1, 9	–	10	3				–	–	3	
	1.5,13.5	–	15	4				–	–	4	
Input High Voltage, V_{IH} Min.	0.5, 4.5	–	5	3.5				3.5	–	–	
	1, 9	–	10	7				7	–	–	
	1.5,13.5	–	15	11				11	–	–	
Input Current I_{IN} Max.	–	0,18	18	±0.1	±0.1	±1	±1	–	$\pm 10^{-5}$	±0.1	μA

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C, C_L = 50 pF, Input t_r, t_f = 20 ns, R_L = 200 kΩ

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS
	V_{DD} (V)	Typ.	Max.	
Propagation Delay Time: t_{PHL}, t_{PLH}	5	175	350	ns
	10	80	160	
	15	60	120	
Transition Time t_{THL}, t_{TLH}	5	100	200	ns
	10	50	100	
	15	40	80	
Input Capacitance, C_{IN}	–	5	7.5	pF

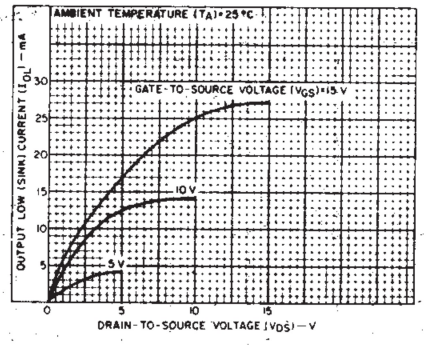


Fig. 2 — Typical output low (sink) current characteristics.

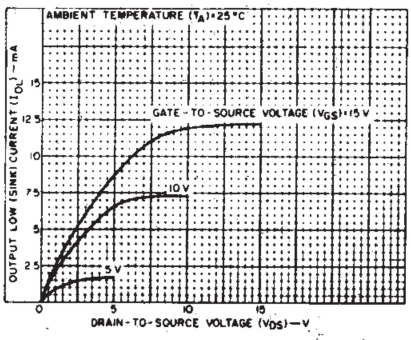


Fig. 3 — Minimum output low (sink) current characteristics.

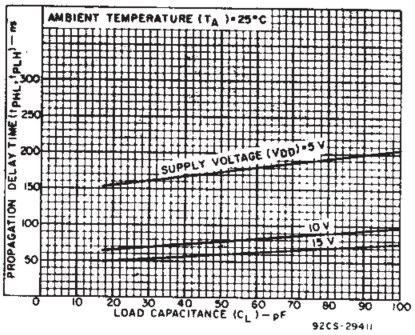


Fig. 4 — Typical propagation delay time as a function of load capacitance.

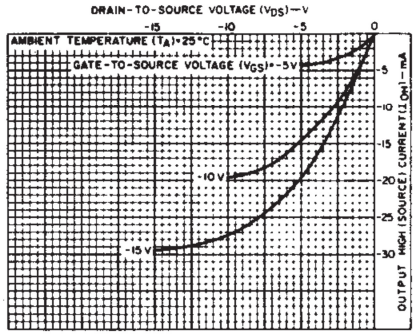


Fig. 5 — Typical output high (source) current characteristics.

TABLE II – CODE CONVERSION CHART

INPUTS				INPUT CODES						OUTPUT NUMBER																
				Hexa-Decimal		Decimal																				
D	C	B	A	4-BIT BINARY	4-BIT GRAY	EXCESS-3	EXCESS-3 GRAY	AIKEN	4-2-2-1	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	0	0	0	0	0			0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	0	1	1	1			1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	0	2	3		0	2	2	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
0	0	1	1	3	2	0	3	3		0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
0	1	0	0	4	7	1	4	4		0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
0	1	0	1	5	6	2			3	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
0	1	1	0	6	4	3	1		4	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
0	1	1	1	7	5	4	2			0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
1	0	0	0	8	15	5				0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
1	0	0	1	9	14	6			5	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
1	0	1	0	10	12	7	9		6	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
1	0	1	1	11	13	8		5		0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
1	1	0	0	12	8	9	5	6		0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
1	1	0	1	13	9		6	7	7	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
1	1	1	0	14	11		8	8	8	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
1	1	1	1	15	10		7	9	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

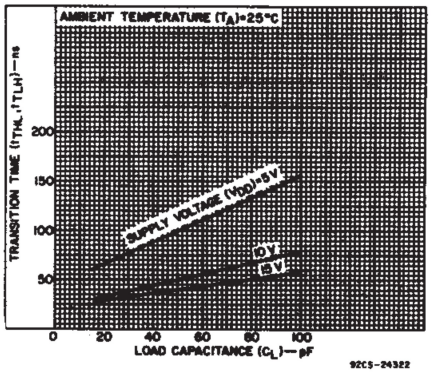


Fig. 8 – Typical transition time as a function of load capacitance.

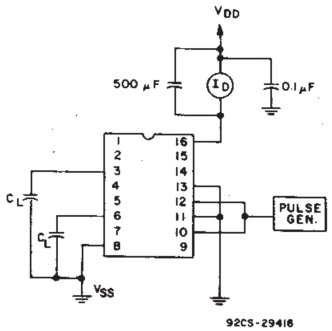


Fig. 10 – Dynamic power dissipation test circuit.

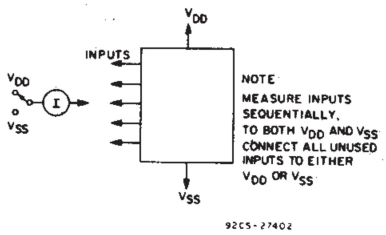


Fig. 9 – Input current test circuit.

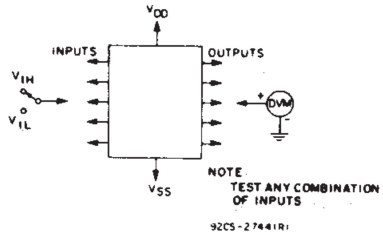


Fig. 11 – Input voltage test circuit.

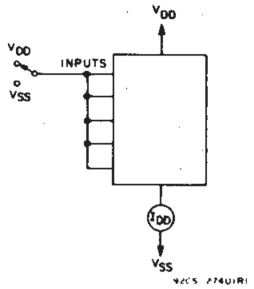


Fig. 12 – Quiescent device current test circuit.

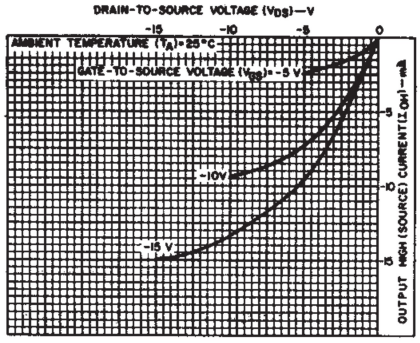


Fig. 6 – Minimum output high (source) current characteristics.

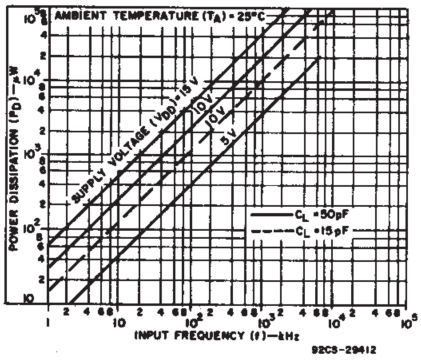


Fig. 7 – Typical dynamic power dissipation as a function of input frequency.

TYPICAL APPLICATIONS

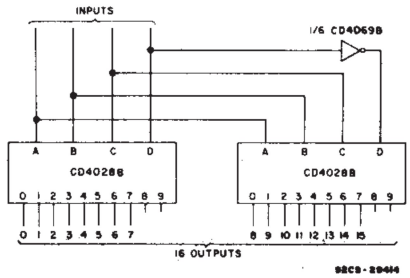
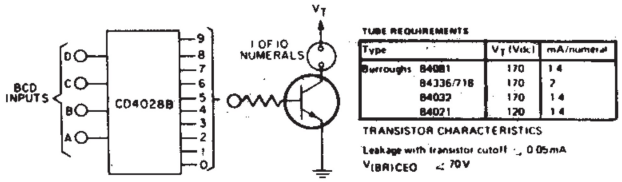


Fig. 13 – Code conversion circuit.

The circuit shown in Fig.13 converts any 4-bit code to a decimal or hexadecimal code. Table 2 shows a number of codes and the decimal or hexadecimal number in these codes which must be applied to the input terminals of the CD4028B to select a particular output. For example: in order to get a high on output No. 8 the input must be either an 8 expressed in 4-Bit Binary code, a 15 expressed in 4-Bit Gray code, or a 5 expressed in Excess-3 code.



▲(Trademark) Burroughs Corp.

Fig. 14 — Neon readout (Nixie Tube▲) display application.

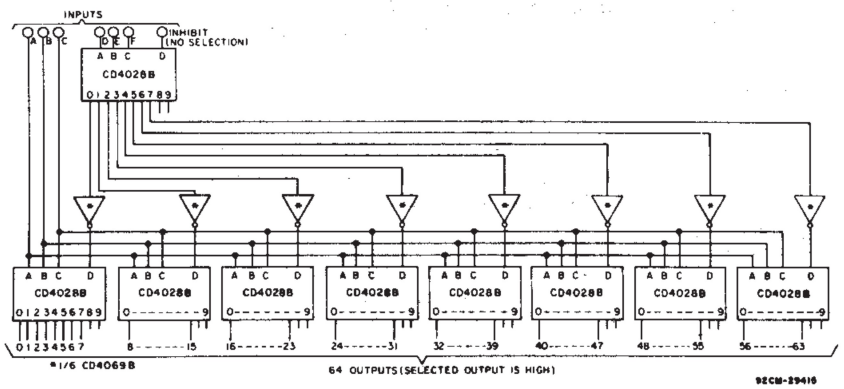
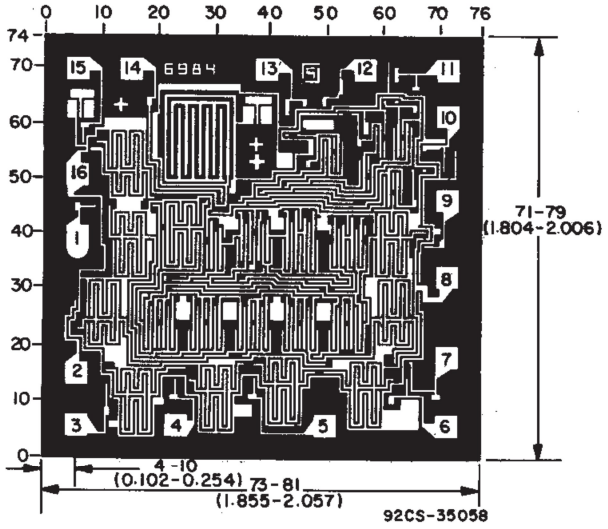


Fig. 15 — 6-bit binary to 1-of-64 address decoder.



CD4028BH
DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).